Atty. Docket No. CPAC 1029-7
-Appl. No. 10/681,584



PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

) Examiner: Alonzo Chambi Application No.: 10/681,584	liss
Application No.: 10/681.584	
) Group Art Unit: 2814	
Filed: October 8, 2003 )	
) Date: 10 October 2005	
Title: Semiconductor multi-package )	
module having inverted second package )	
and including additional die or stacked )	
package on second package )	
) CERTIFICATE OF MAILING	

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to: MS Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, M 10 October 2005.

Signed

Bill Kennedy

## **AMENDMENT**

Dear Sir:

Responsive to the Office action mailed August 4, 2005, kindly amend the application as follows.

Amendments to the Claims are reflected in the Listing of Claims, which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.